

V_{DSS}	-20V
$R_{DS(on)}(Max.)$	3.8Ω
I_D	±100mA
P_D	100mW

●Features

- 1) Ultra Small Package (0.6×0.4×0.36mm)
- 2) Low voltage drive (-1.5V) makes this device ideal for portable equipment.
- 3) Drive circuits can be simple.
- 4) Built-in ESD Protection Diode.

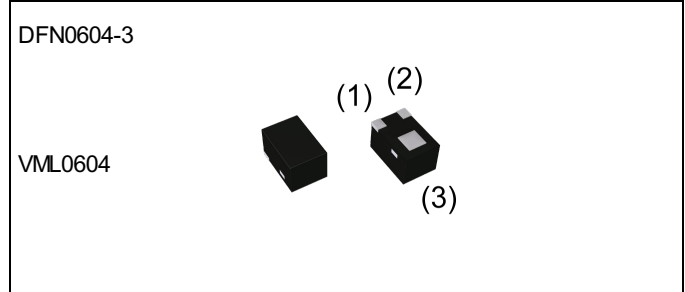
●Application

Reverse voltage protection
Overvoltage protection

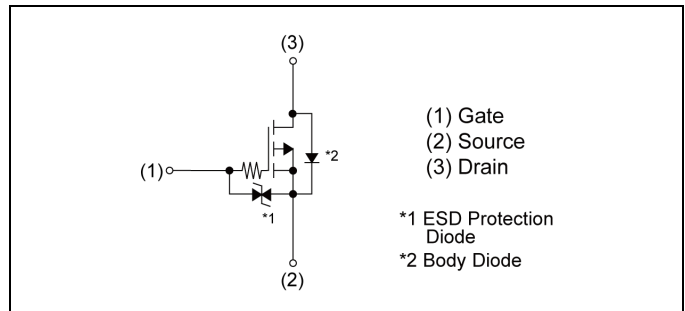
●Absolute maximum ratings ($T_a = 25^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V_{DSS}	-20	V
Continuous drain current	I_D^{*1}	±100	mA
Pulsed drain current	I_{DP}^{*2}	±400	mA
Gate - Source voltage	V_{GSS}	±10	V
Power dissipation	P_D^{*3}	100	mW
	P_D^{*4}	110	mW
Junction temperature	T_j	150	°C
Operating junction and storage temperature range	T_{stg}	-55 to +150	°C

●Outline



●Inner circuit



●Packaging specifications

Type	Packing	Embossed Tape
	Reel size (mm)	180
	Tape width (mm)	8
	Basic ordering unit (pcs)	8000
	Taping code	T2CL
	Marking	RZ

● Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - ambient	R_{thJA}^{*3}	-	-	1250	°C/W

● Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -1mA$	-20	-	-	V
ESD Protection Diode Zener Voltage	V_{GSS}	$I_{GS} = -11mA, V_{DS} = 0V$	-6.8	-	-10	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	$I_D = -1mA$ referenced to 25°C	-	-21.9	-	mV/°C
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -20V, V_{GS} = 0V$	-	-	-1	μA
Gate - Source leakage current	I_{GSS}	$V_{GS} = \pm 4V, V_{DS} = 0V$	-	-	± 100	μA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -100\mu\text{A}$	-0.3	-	-1.0	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	$I_D = -1mA$ referenced to 25°C	-	2.4	-	mV/°C
Static drain - source on - state resistance	$R_{DS(on)}^{*5}$	$V_{GS} = -4.5V, I_D = -100mA$	-	2.5	3.8	Ω
		$V_{GS} = -2.5V, I_D = -50mA$	-	3.4	5.1	
		$V_{GS} = -1.5V, I_D = -10mA$	-	6.0	13.2	

*1 Limited only by maximum temperature allowed.

*2 $P_w \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$

*3 Each terminal mounted on a recommended land

*4 $P_w \leq 5\text{s}$, Duty cycle $\leq 1\%$

*5 Pulsed

●Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Input capacitance	C_{iss}	$V_{GS} = 0V$	-	7.5	-	pF
Output capacitance	C_{oss}	$V_{DS} = -10V$	-	4.0	-	
Reverse transfer capacitance	C_{rss}	$f = 1\text{MHz}$	-	1.0	-	
Turn - on delay time	$t_{d(on)}^{*5}$	$V_{DD} \approx -10V, V_{GS} = -4.5V$	-	80	-	ns
Rise time	t_r^{*5}	$I_D = -50\text{mA}$	-	85	-	
Turn - off delay time	$t_{d(off)}^{*5}$	$R_L \approx 200\Omega$	-	600	-	
Fall time	t_f^{*5}	$R_G = 10\Omega$	-	250	-	

●Body diode electrical characteristics (Source-Drain) ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Continuous forward current	I_S^{*1}	$T_a = 25^\circ\text{C}$	-	-	-80	mA
Pulse forward current	I_{SP}^{*2}		-	-	-400	mA
Forward voltage	V_{SD}^{*5}	$V_{GS} = 0V, I_S = -100\text{mA}$	-	-	-1.2	V

● Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

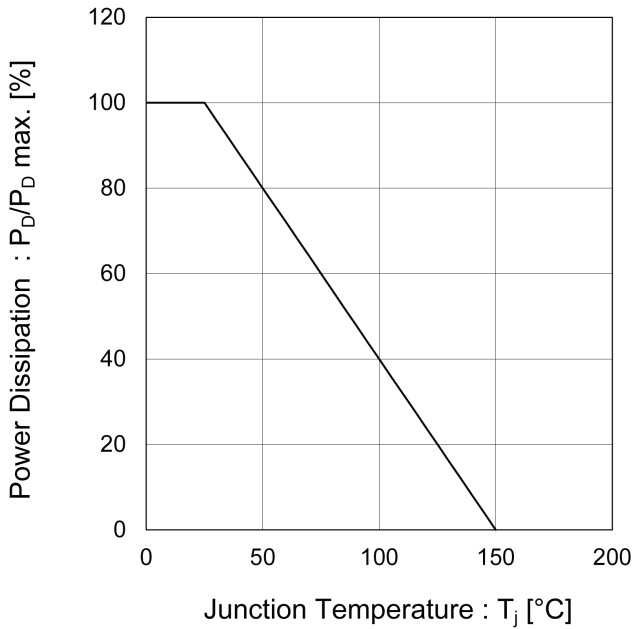


Fig.2 Typical Output Characteristics(I)

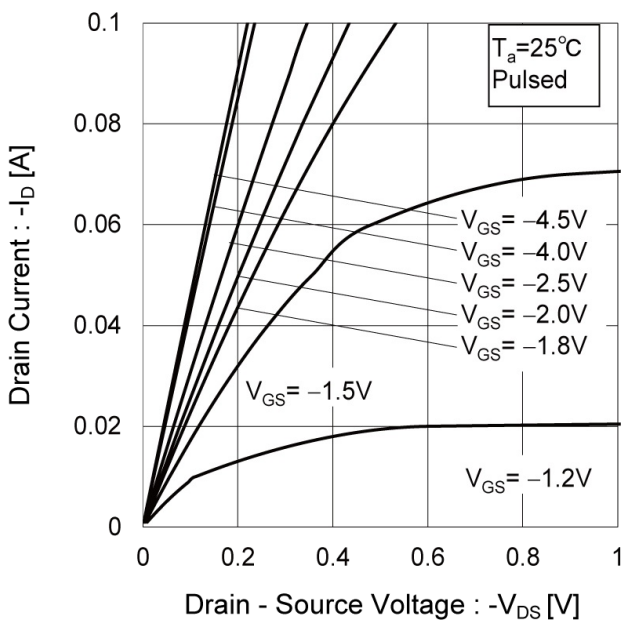
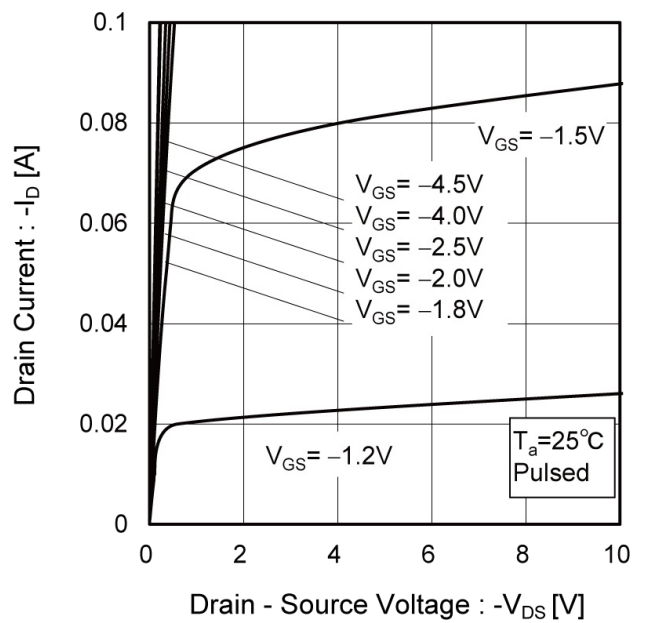


Fig.3 Typical Output Characteristics(II)



● Electrical characteristic curves

Fig.4 Breakdown Voltage vs. Junction Temperature

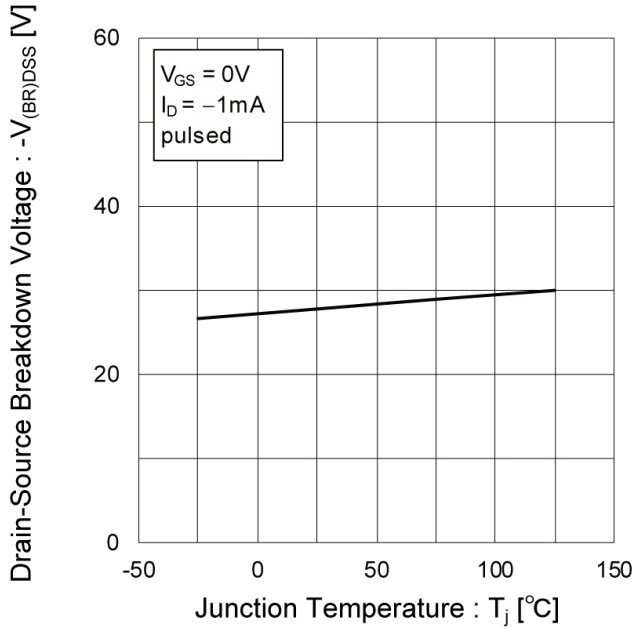


Fig.5 Typical Transfer Characteristics

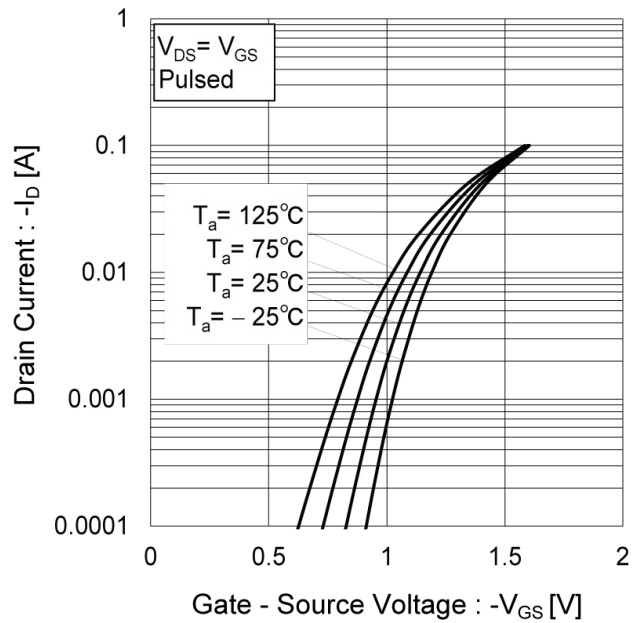
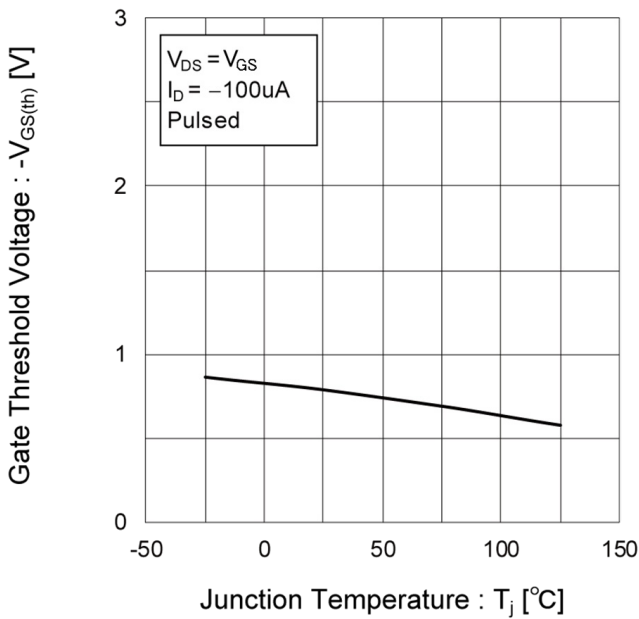


Fig.6 Gate Threshold Voltage vs. Junction Temperature



● Electrical characteristic curves

Fig.7 Drain Current Derating Curve

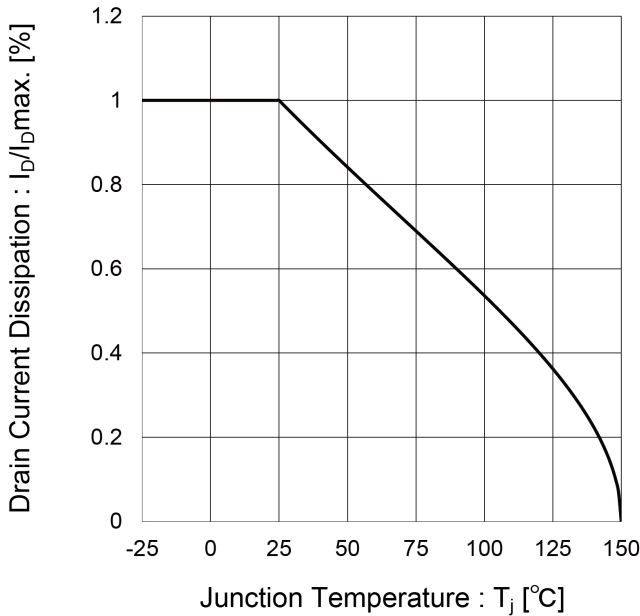


Fig.8 Static Drain - Source On - State Resistance vs. Gate Source Voltage

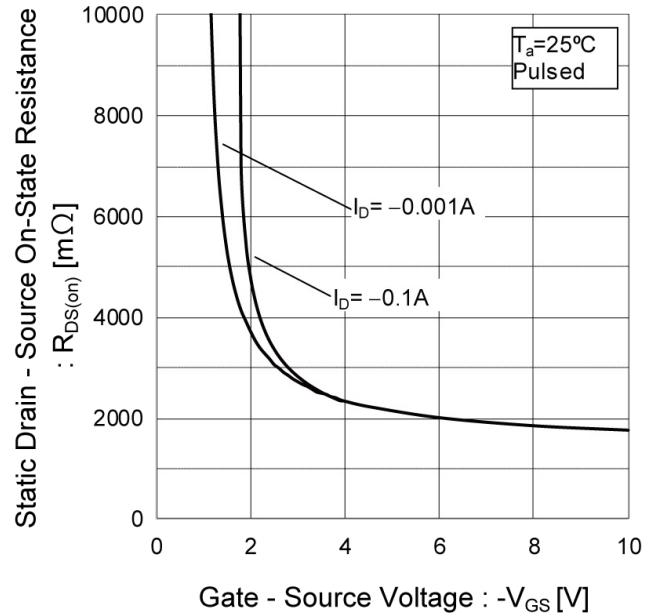


Fig.9 Static Drain - Source On - State Resistance vs. Junction Temperature

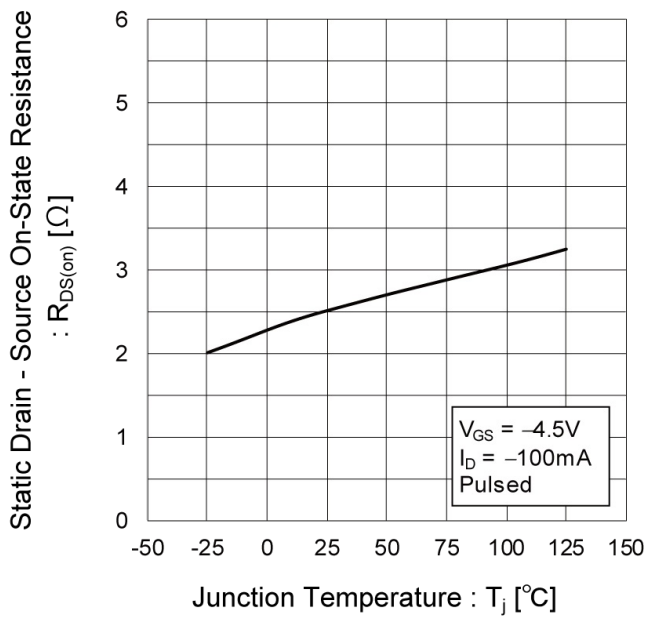
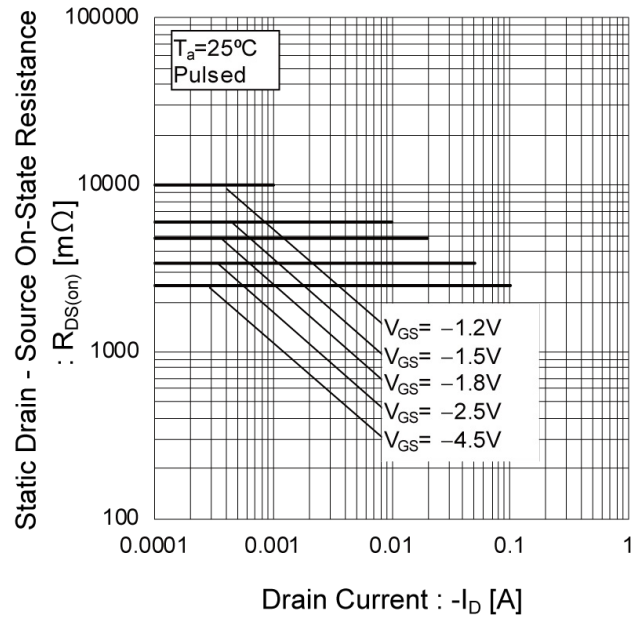


Fig.10 Static Drain - Source On - State Resistance vs. Drain Current(I)



● Electrical characteristic curves

Fig.11 Static Drain - Source On - State Resistance vs. Drain Current(II)

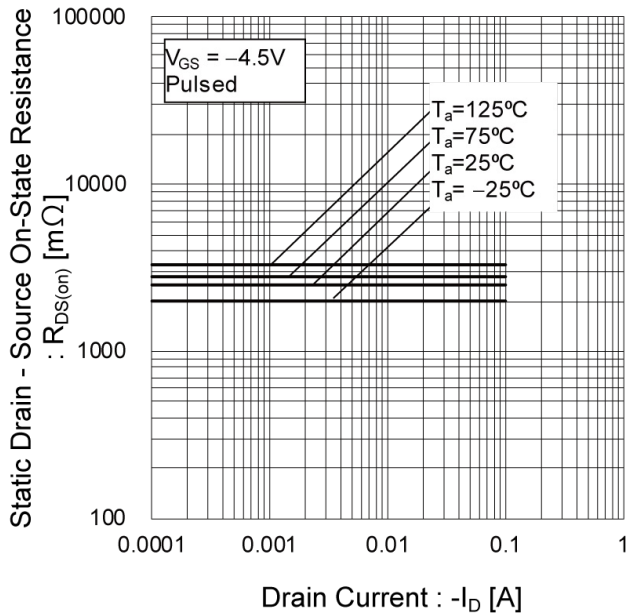


Fig.12 Static Drain - Source On - State Resistance vs. Drain Current(III)

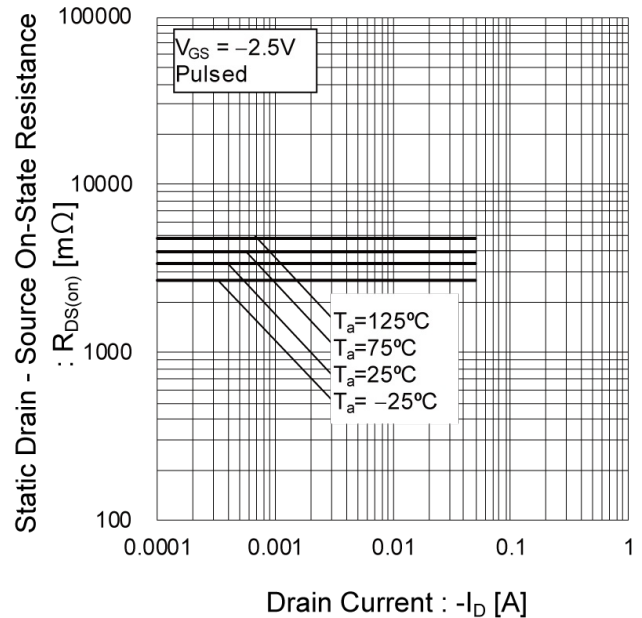


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current(IV)

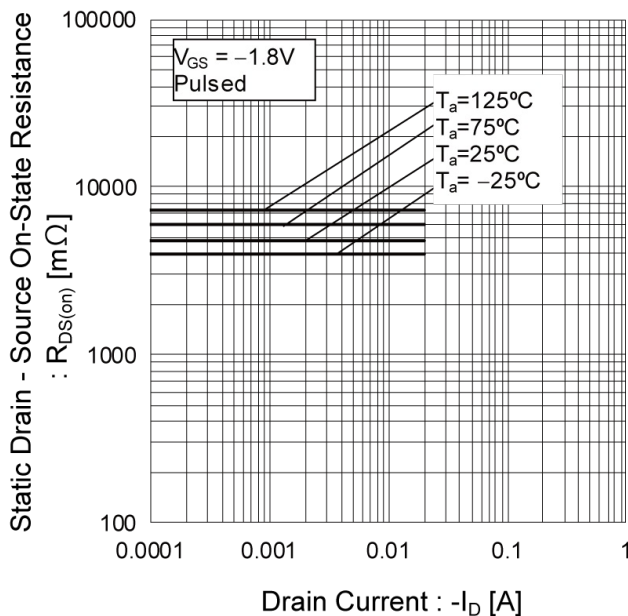
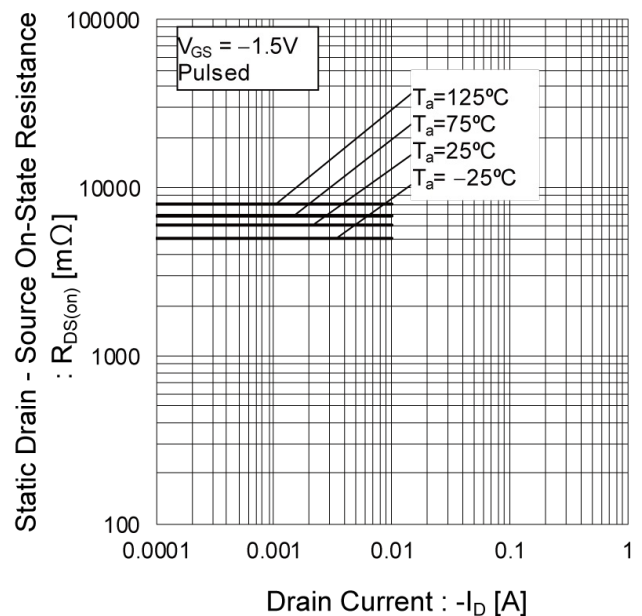


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current(V)



● Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current(VI)

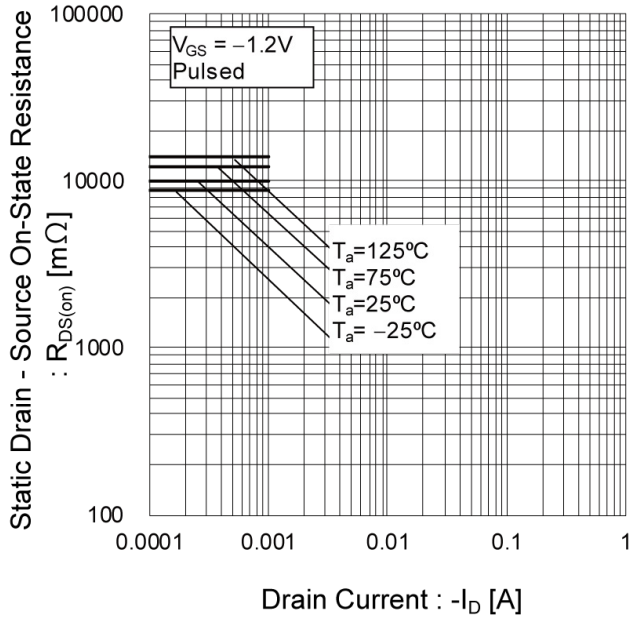


Fig.16 Typical Capacitance vs. Drain - Source Voltage

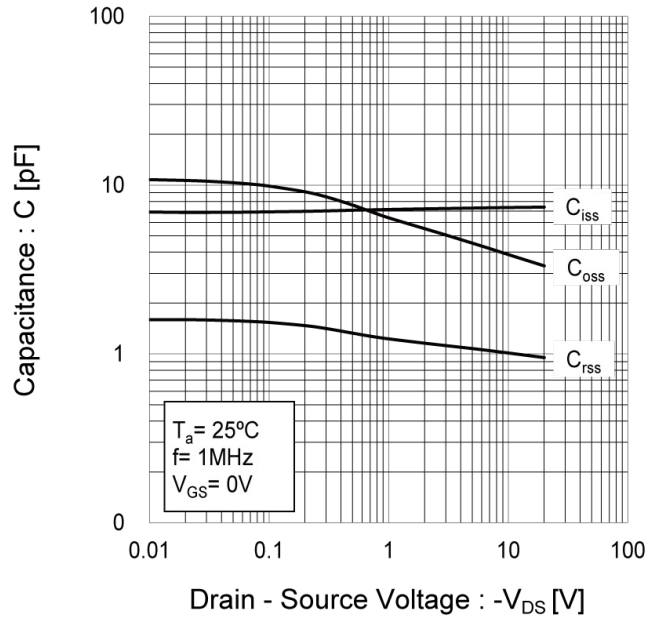


Fig.17 Switching Characteristics

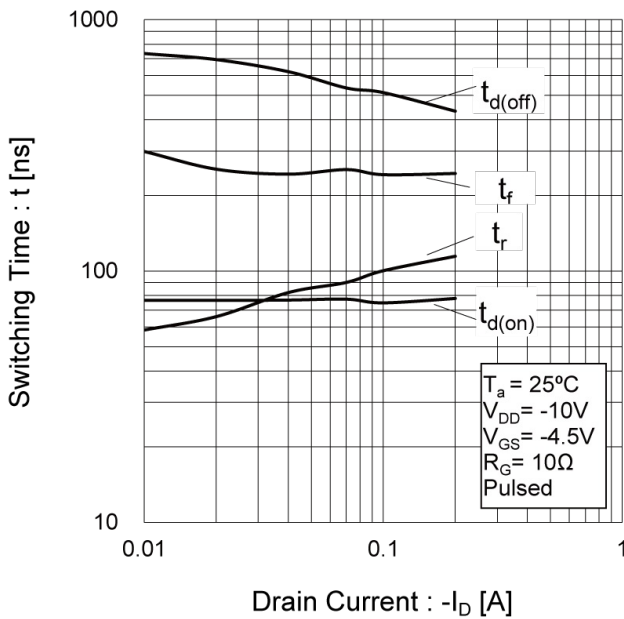
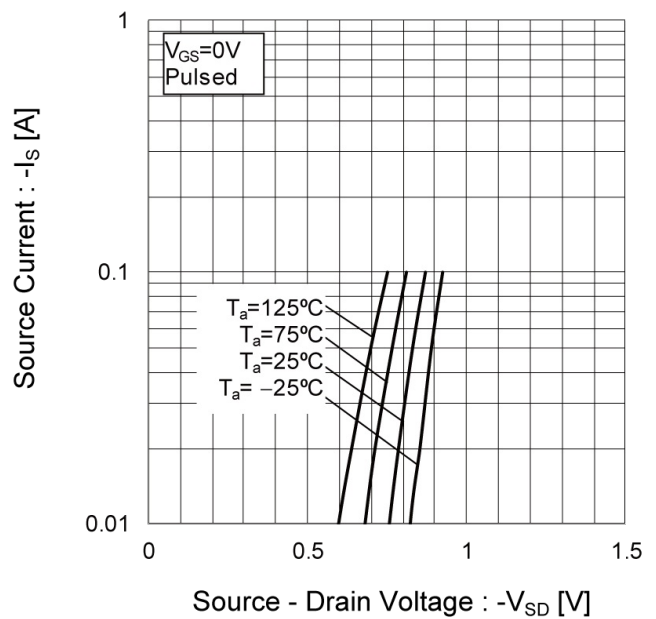


Fig.18 Source Current vs. Source Drain Voltage



● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

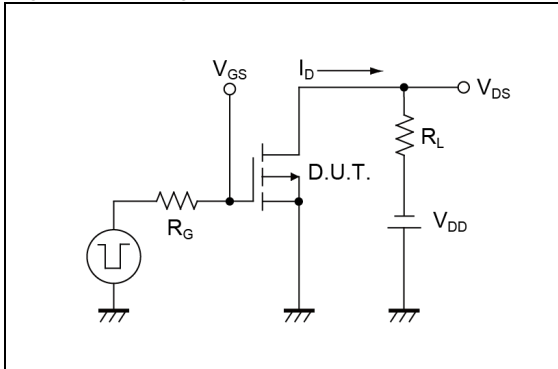
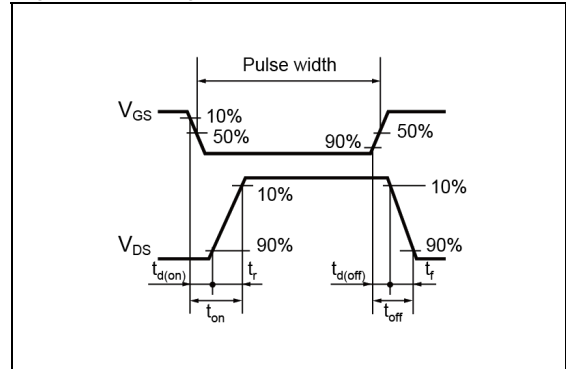


Fig.1-2 Switching Waveforms

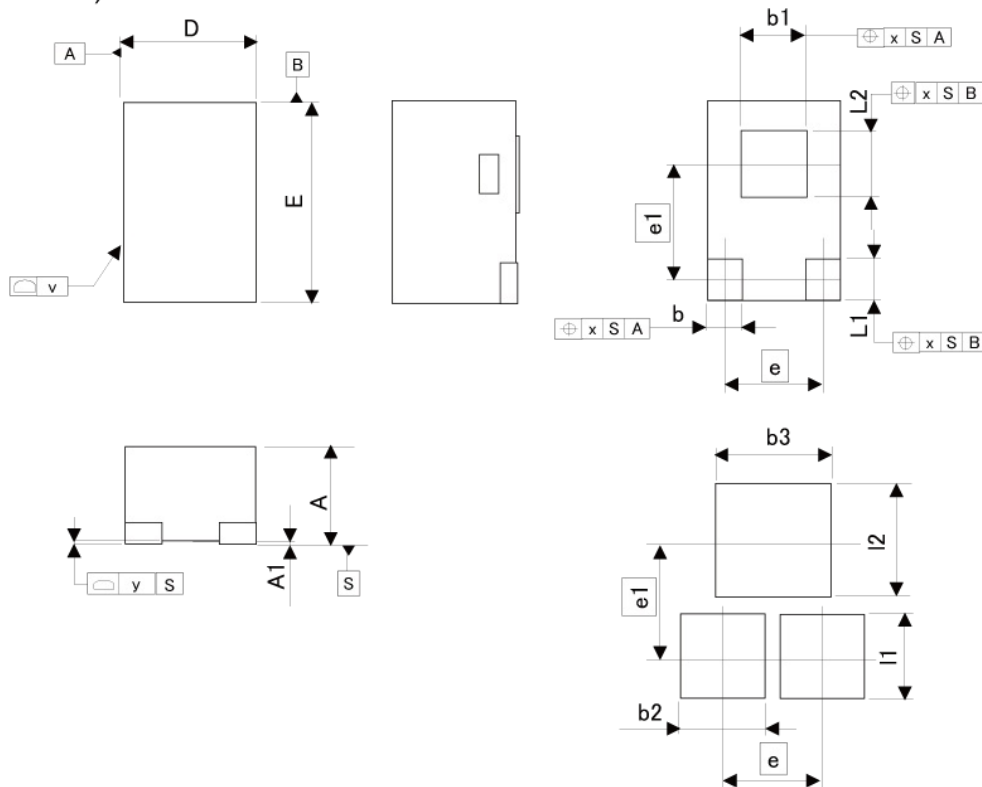


● Notice

This product might cause chip aging and breakdown under the large electrified environment.
Please consider to design ESD protection circuit.

●Dimensions

DFN0604-3
(VML0604)



Pattern of terminal position areas
[Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.33	0.39	0.013	0.015
A1	0.00	0.05	0.000	0.002
b	0.05	0.15	0.002	0.006
b1	0.15	0.25	0.006	0.010
D	0.35	0.45	0.014	0.018
E	0.55	0.65	0.022	0.026
e	0.30		0.012	
e1	0.35		0.014	
L1	0.07	0.17	0.003	0.007
L2	0.15	0.25	0.006	0.010
x	-	0.10	-	0.004
y	-	0.10	-	0.004
v	-	0.05	-	0.002

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.25	-	0.010
b3	-	0.35	-	0.014
l1	-	0.27	-	0.011
l2	-	0.35	-	0.014

Dimension in mm/inches

Notice

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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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 - Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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RV3CA01ZP - Web Page

[Distribution Inventory](#)

Part Number	RV3CA01ZP
Package	VML0604
Unit Quantity	8000
Minimum Package Quantity	8000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes